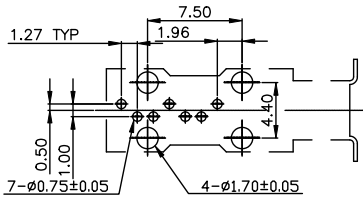
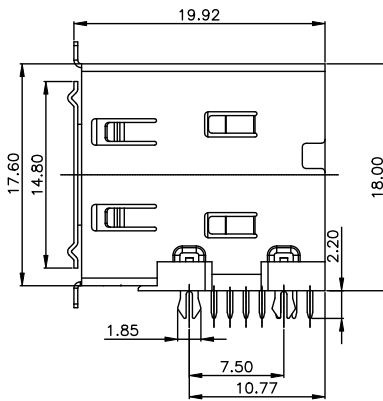
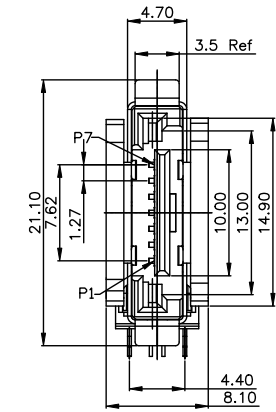


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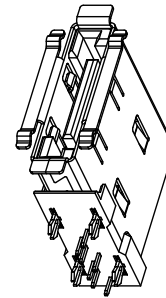
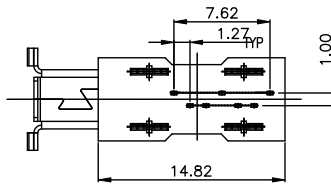


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- NOTES:
- MATERIAL:
HOUSING:THERMALPLASTIC HIGH TEMP WITH 30G/F UL94 V-0
COLOR:BLACK
CONTACT:COPPER ALLOY
SHELL/BOARD LOCK: COPPER ALLOY
 - FINISH:
CONTACT:GOLD PLATING ON CONTACT AREA
100u" MIN. MATT TIN PLATING ON SOLDERTAILS
50u" MIN.NICKEL UNDERPLATING OVER ALL
SHELL/BOARD LOCK:50 u" MIN.NICKEL PLATING OVER ALL
 - THE HOUSING WILL WITHSTAND TO 260C FOR 10 SEC IN A WAVE SOLDER APPLICATION WITH A 1.6MM PCB
 - PRODUCT SPEC : GS-12-386
PACKING SPEC : GS-14-1109
 - PRODUCT NUMBERING:
10074141 -0 0 X X LF — LEAD FREE
PACKING:
BLANK: TRAY PACKING
1: 15u" GOLD PLATING
2: G/F GOLD PLATING



P.C. BOARD MOUNTING DIMENSIONS T=1.60mm
PCB TOLERANCE: ±0.05



PIN DEFINITION

ESATA	NAME	TYPE
P1	GND	
P2	A+	
P3	A-	
P4	GND	
P5	B-	
P6	B+	
P7	GND	

mat'l. code	surface	tolerance	projection	product family
				533
ltr	ecn	no	dr	date
A	T07-1074	S.LIN	07-5-23	
B	T08-1082	S.LIN	08-4-29	
C	T10-0184	S.LIN	10-12-14	
tolerances unless otherwise specified				
angles	.XX±0.38		title	
flatness	.XX±0.25		ESATA UP RIGHT DIP TYPE	
total run out	.XXX±0.10		scale N/A	
dr	STERLING LIN	05/21/07	dwg no	
eng	STERLING LIN	05/23/07	sheet 1 of 1 size	
chr	STERLING LIN	05/23/07	10074141	
app	MINERVA WAN	05/23/07	A4	
sheet	revision	C	type CUSTOMER Drawing	
index	sheet	1		

form: A4mmXLI

PDM: Rev: C 3 STATUS: Released Printed: Feb 14, 2011 4